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In re the application of:

Kousuke SUZUKI, et al.

Serial Number: 09/045,118

Group Art Unit: 2823

Examiner: Na Berez

Berezny

Filed: March 20, 1998

For: SEMICONDUCTOR DEVICE HAVING AN INSULATION FILM WITH REDUCE!

WATER CONTENT (AS AMENDED)

PRELIMINARY AMENDMENT

Director of Patents and Trademarks Washington, D.C. 20231

April 15, 2002

Sir:

Prior to continued prosecution, please amend the application as follows:

IN THE SPECIFICATION:

Please replace the paragraph beginning at page 15, line 24, with the following, rewritten paragraph:

--Referring to FIGS. 3 and 4, it can be seen that a substantial release of H₂O

and OH occurs in the SiO₂ film deposited under a conventional plasma power of .

200W immediately after the start of the heating. The release of H₂O and OH

continues even when the temperature reaches 1000°C.--

